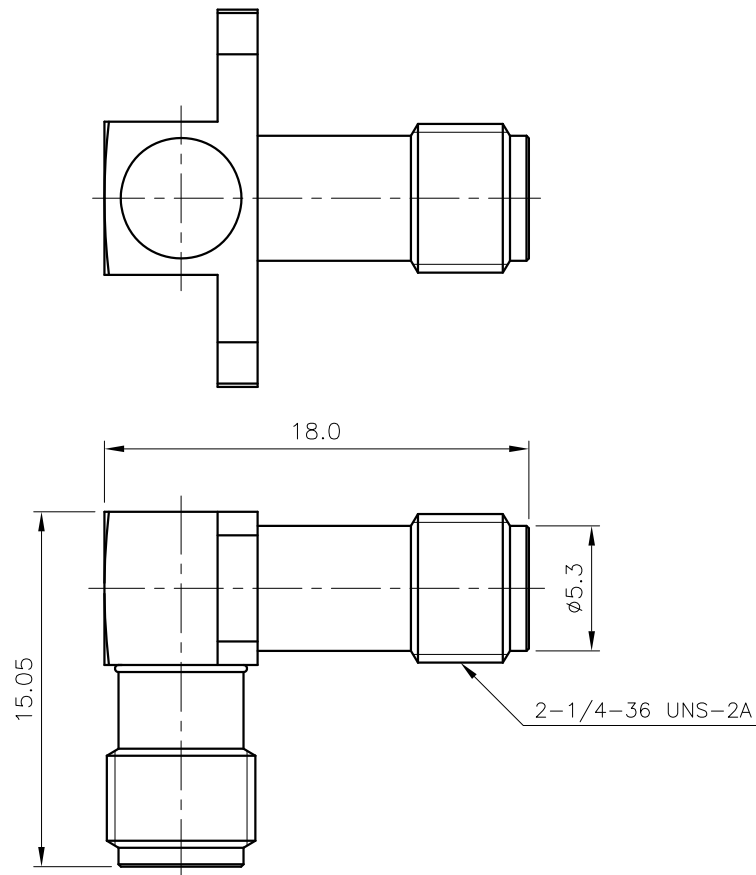


A

B

C

D



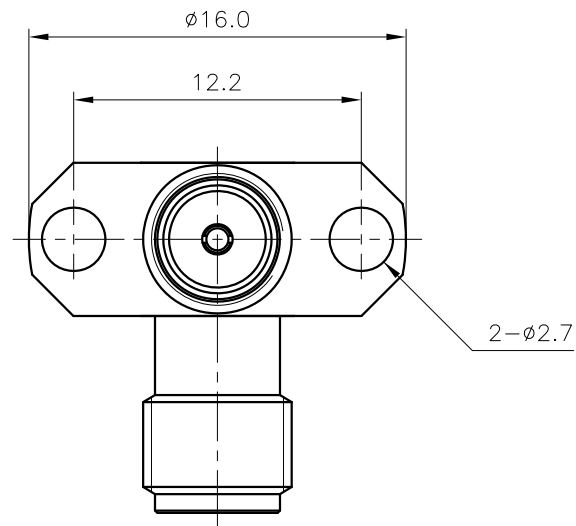
REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	S.M.LEE	I.C.KIM	2015.11.27.
1	AB/용접 → A+B/용접 구조 변경	S.Y.EUN	I.C.KIM	2021.01.21.
2	도금 작업시 핀 부러짐 발생 치수 조정	S.H.KIM		2023.03.31.

A

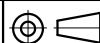
B

C

D



2	6	COVER	1	MBsBD C3604BD-F	Nickel Plate	DCO00026-5/1		
	5	INSULATOR	1	TEFLON		DIN00103-N/1		
	4	INSULATOR	1	TEFLON		DIN00154-N/1		
	3	CONTACT	1	BeCu C17300	Gold Plate	DCT03601-5/1		
	2	CONTACT	1	BeCu C17300	Gold Plate	DCT02874-5/1		
1	1	1-2	BODY	1	MBsBD C3604BD-F	Nickel Plate	DBB00433-5/1	DBD04079-3/1
1		1-1	BODY	1	MBsBD C3604BD-F	Nickel Plate		DBD04081-3/1
	NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE		

TOLERANCE	Decimal ±0.2	DATE 2023. 03. 31.			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle ±1°	APPROVED BY			
MATERIAL _____		CHECKED BY			TITLE SMA (J) SMA50 (J) RA-2H ADAPTOR
FINISH _____		DRAWN BY S.H.KIM			
		SCALE 3/1	UNIT mm		DWG NO. AD00574-7/1
					REVISION 2
					SHEET 1 of 1